

## Product Summary

| $V_{RRM}$ (V) | $I_o$ (A) | $V_F(MAX)$ (V)<br>@ +25°C | $I_R(MAX)$ (mA)<br>@ +25°C |
|---------------|-----------|---------------------------|----------------------------|
| 60            | 2         | 0.65                      | 0.2                        |

## Description and Applications

The schottky rectifier providing low  $V_F$  and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

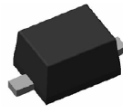
## Features and Benefits

- Reduced Low Forward Voltage Drop ( $V_F$ ); Better Efficiency and Cooler Operation
- Reduced High-temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

## Mechanical Data

- Case: SOD123F (Generic)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)

SOD123F  
(Generic)



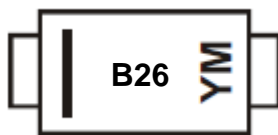
Top View

## Ordering Information (Note 4)

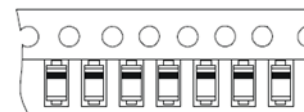
| Part Number | Case              | Packaging         |
|-------------|-------------------|-------------------|
| B260S1F-7   | SOD123F (Generic) | 3,000/Tape & Reel |

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



B26 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: E = 2017)  
 M = Month (ex: 2 = February)



### Date Code Key

| Year | 2015 | 2016 | 2017 | 2018 | 2019 | 2020 | 2021 | 2022 |
|------|------|------|------|------|------|------|------|------|
| Code | C    | D    | E    | F    | G    | H    | I    | J    |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code  | 1   | 2   | 3   | 4   | 5   | 6   | 7   | 8   | 9   | O   | N   | D   |

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

| Characteristic  | Symbol           | Value | Unit |
|---|------------------|-------|------|
| Peak Repetitive Reverse Voltage   | V <sub>RRM</sub> | 60    | V    |
| Working Peak Reverse Voltage  | V <sub>RWM</sub> |       |      |
| DC Blocking Voltage   | V <sub>RM</sub>  |       |      |
| Average Rectified Output Current  | I <sub>O</sub>   | 2     | A    |
| Non-Repetitive Peak Forward Surge Current 8.3ms<br>Single Half Sine-Wave Superimposed on Rated Load | I <sub>FSM</sub> | 50    | A    |

**Thermal Characteristics**

| Characteristic  | Symbol                            | Value       | Unit |
|---|-----------------------------------|-------------|------|
| Typical Thermal Resistance Junction to Ambient (Note 5) | R <sub>θJA</sub>                  | 100         | °C/W |
| Typical Thermal Resistance Junction to Case (Note 5)    | R <sub>θJC</sub>                  | 50          | °C/W |
| Operating and Storage Temperature Range                 | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic           | Symbol         | Min | Typ  | Max  | Unit | Test Condition  |
|--------------------------|----------------|-----|------|------|------|---|
| Forward Voltage Drop     | V <sub>F</sub> | —   | 0.55 | 0.65 | V    | I <sub>F</sub> = 2A, T <sub>J</sub> = +25°C<br>I <sub>F</sub> = 2A, T <sub>J</sub> = +125°C   |
| Leakage Current (Note 6) | I <sub>R</sub> | —   | 0.02 | 0.2  | mA   | V <sub>R</sub> = 60V, T <sub>J</sub> = +25°C<br>V <sub>R</sub> = 60V, T <sub>J</sub> = +125°C |
| Typical Capacitance      | C <sub>T</sub> | —   | 75   | —    | pF   | V <sub>R</sub> = 4.0V, f = 1MHz   |

- Notes:
5. Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad.
  6. Short duration pulse test used to minimize self-heating effect.

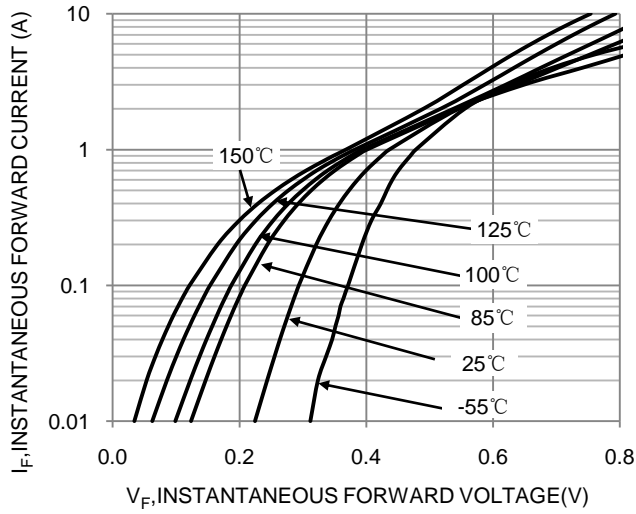


Figure 1. Typical Forward Characteristics

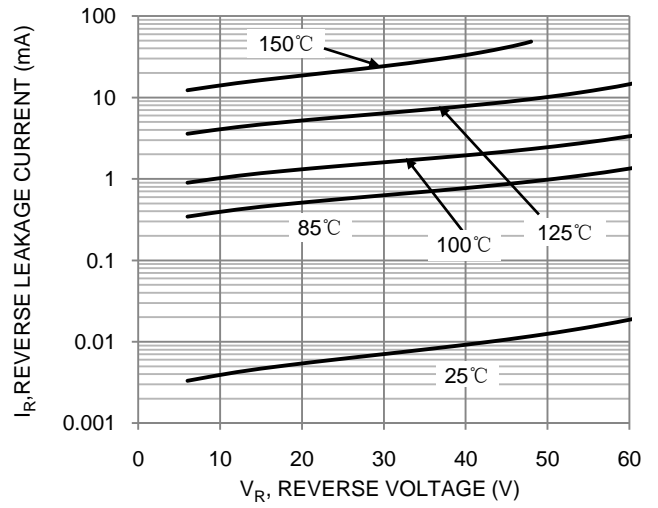


Figure 2. Typical Reverse Characteristics

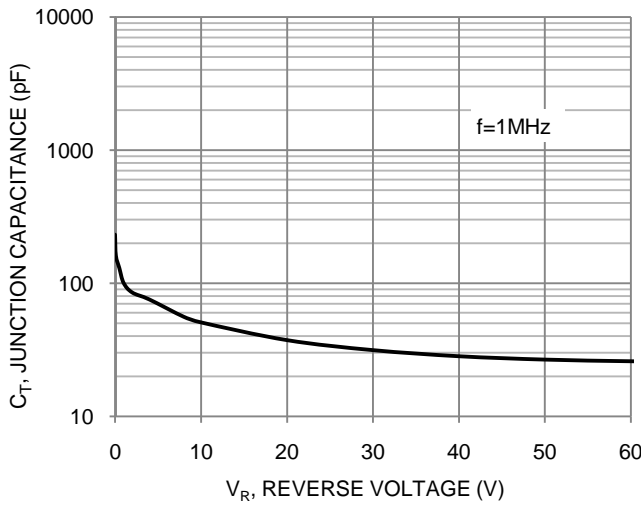


Figure 3. Typical Junction Capacitance

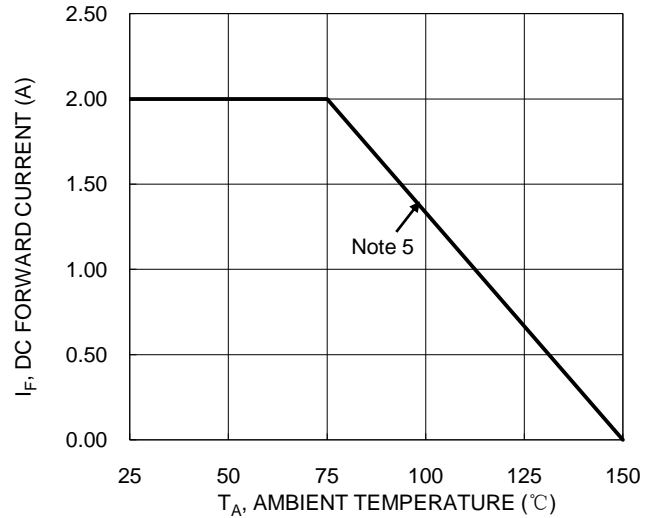
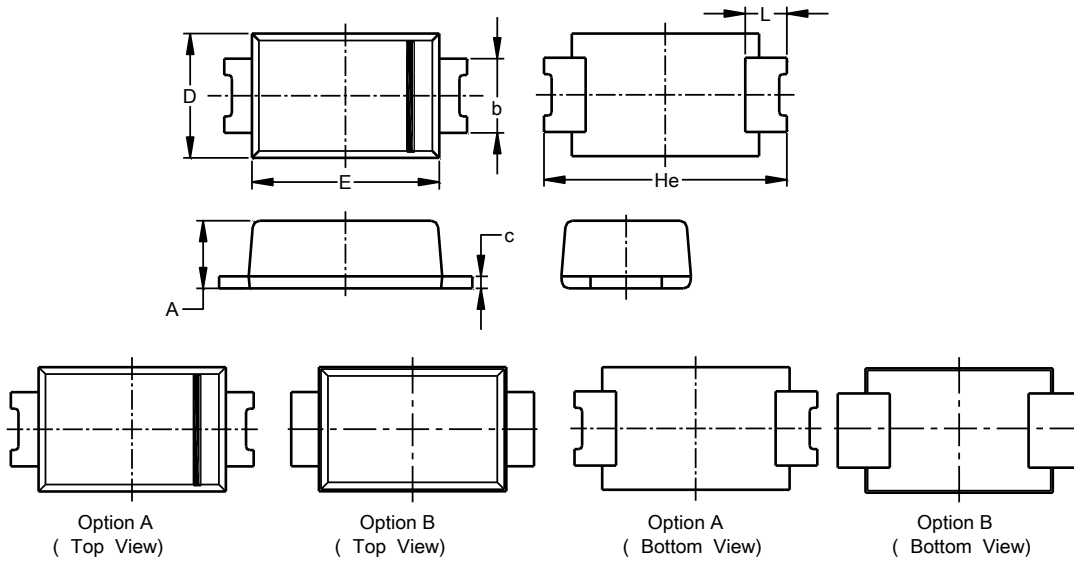


Figure 4. DC Forward Current Derating

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOD123F (Generic)**



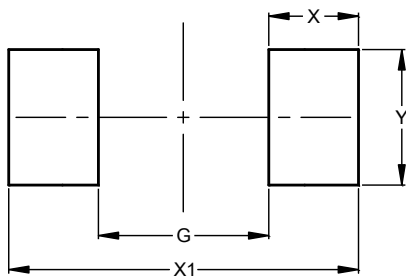
| SOD123F (Generic)    |      |      |      |
|----------------------|------|------|------|
| Dim                  | Min  | Max  | Typ  |
| A                    | 0.81 | 1.15 | -    |
| b                    | 0.80 | 1.35 | -    |
| c                    | 0.05 | 0.30 | -    |
| D                    | 1.70 | 1.90 | 1.80 |
| E                    | 2.60 | 2.80 | 2.70 |
| He                   | 3.30 | 3.70 | 3.50 |
| L                    | 0.35 | 0.85 | -    |
| All Dimensions in mm |      |      |      |

NEW PRODUCT

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOD123F (Generic)**



| Dimensions | Value (in mm) |
|------------|---------------|
| G          | 1.90          |
| X          | 1.00          |
| X1         | 3.90          |
| Y          | 1.50          |

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